TOSHIBA Diodes For Protecting Against ESD Epitaxial Planar Type

DF5A8.2LF

Diodes for Protecting Against ESD

- Because four devices are mounted on an ultra compact package, it is possible to allow reducing the number of the parts and the mounting cost.
- Zener voltage correspond to E24 Series.
- Low total capacitance: $C_T = 5.0 \text{ pF (typ.)}$

Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Power dissipation	Р	200	mW
Junction temperature	Tj	125	°C
Storage temperature range	T _{stg}	-55 to 125	°C

Unit in mm +0.2 2.8-0.3 +0.2 1.6-0.1 1. CATHODE1 4. CATHODE3 2. ANODE 5. CATHODE4 3. CATHODE2 SMV JEDEC — EIAJ — TOSHIBA 1-3H1A

Electrical Characteristics (Ta = 25°C)

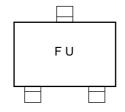
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Zener voltage	Vz	$I_Z = 5 \text{ mA}$	7.8	8.2	8.6	V
Dynamic impedance	Z _Z	$I_Z = 5 \text{ mA}$	_	_	60	Ω
Knee dynamic impedance	Z _{ZK}	$I_Z = 0.5 \text{ mA}$	_	_	100	Ω
Reverse current	I _R	V _R = 5 V	_	_	0.5	μΑ
Total capacitance	C _T	$V_R = 0 V, f = 1 MHz$		5.0	_	pF

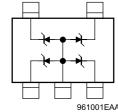
Guaranteed Level of ESD Immunity

Test Condition ESD Immunity Level IEC61000-4-2 (contact discharge) ±6 kV

Marking

Equivalent Circuit (top view)





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